

Amendments to the Specification:

Please replace paragraph [0018] beginning on page 3, with the following amended paragraph:

Figure 13 shows how the frame attachment[[s]] is [[are]] attached t[[w]]o the module;

Please replace paragraph [0072] beginning on page 21, with the following amended paragraph:

The frame segment as shown in figure 3 includes three connected parts. A printed circuit board 305 may include electronics including a microcontroller. The printed circuit board is formed with alignment holes 308 therein. The top enclosure of the frame assembly, 310 includes alignment studs such as [[312]] 315. Each of the alignment holes 308 is next to a respective one of the alignment studs [[312]] 315, such that the outer surfaces of the alignment studs [[312]] 315 maintain the inner surfaces of the hole 308 in position. The bottom baseplate 320 covers the printed circuit board 305 and may screw into the studs 330, 332.

Please replace paragraph [0074] beginning on page 21, with the following amended paragraph:

Figure 11A shows the electronic frame attachment USB controller frame attachments, which has signal style pins 1100, 1102, 1104, 1106, and power supply pins 1108, 1110. This provides both signal and power to the array. The power supply attachment is shown in figure 11B, only having a printed circuit board populated with electronic power filtering components having power pins 1112, 1114 and signal control pins 1100, 1102, 1104, 1106. ~~only having power supply pins 1112, 1114.~~ A An optional cosmetic frame attachment shown in figure 11c also has a printed circuit board, power supply and signal pins void of electronic components. A cosmetic frame attachments shown in figure 11C has no connecting pins.